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April 2005

FAN2001/FAN2002
1A High-Efficiency Step-Down DC-DC Converter

Features

- 96% Efficiency, Synchronous Operation
- Adjustable Output Voltage Options from 0.8V to V_{IN}
- 2.5V to 5.5V Input Voltage Range
- Up to 1A Output Current
- Fixed Frequency 1.3MHz PWM Operation
- High Efficiency Power Save Mode
- 100% Duty Cycle Low Dropout Operation
- Soft Start
- Output Over-Voltage Protection
- Dynamic Output Voltage Positioning
- 25µA Quiescent Current
- Thermal Shutdown and Short Circuit Protection
- Pb-Free 3x3mm 6-Lead MLP Package

Applications

- Pocket PCs, PDAs
- Cell Phones
- Battery-Powered Portable Devices
- Digital Cameras
- Hard Disk Drives
- Set-Top-Boxes
- Point-of-Load Power
- Notebook Computers
- Communications Equipment

Description

Designed for use in battery-powered applications, the FAN2001/FAN2002 is a high-efficiency, low-noise synchronous PWM current mode and Pulse Skip (Power Save) mode DC-DC converter. It can provide up to 1A of output current over a wide input range from 2.5V to 5.5V. The output voltage can be externally adjusted over a wide range of 0.8V to 5.5V by means of an external voltage divider.

At moderate and light loads, pulse skipping modulation is used. Dynamic voltage positioning is applied, and the output voltage is shifted 0.8% above nominal value for increased headroom during load transients. At higher loads the system automatically switches over to current mode PWM control, operating at 1.3 MHz. A current mode control loop with fast transient response ensures excellent line and load regulation. To achieve high efficiency and ensure long battery life, the quiescent current is reduced to 25µA in Power Save mode, and the supply current drops below 1µA in shut-down mode. The FAN2001/FAN2002 is available in a 3x3mm 6-lead MLP package.

Typical Application

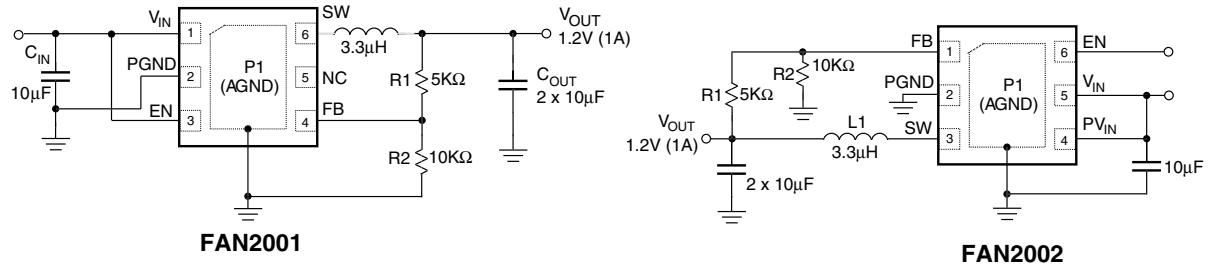

Figure 1. Typical Application

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Pin Assignment

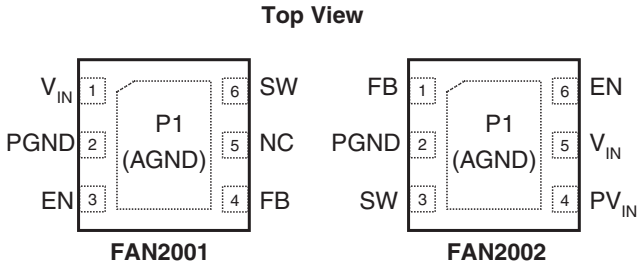


Figure 2. Pin Assignment

Pin Description

FAN2001 (3x3mm 6-Lead MLP)

Pin No.	Pin Name	Pin Description
P1	AGND	**Analog Ground.** P1 must be soldered to the PCB ground.
1	V_{IN}	**Supply Voltage Input.**
2	PGND	**Power Ground.** This pin is connected to the internal MOSFET switches. This pin must be externally connected to AGND.
3	EN	**Enable Input.** Logic high enables the chip and logic low disables the chip, reducing the supply current to less than 1µA. Do not float this pin.
4	FB	**Feedback Input.** Adjustable voltage option, connect this pin to the resistor divider.
5	NC	**No Connection Pin.**
6	SW	**Switching Node.** This pin is connected to the internal MOSFET switches.

FAN2002 (3x3mm 6-Lead MLP)

Pin No.	Pin Name	Pin Description
P1	AGND	**Analog Ground.** P1 must be soldered to the PCB ground.
1	FB	**Feedback Input.** Adjustable voltage option, connect this pin to the resistor divider.
2	PGND	**Power Ground.** This pin is connected to the internal MOSFET switches. This pin must be externally connected to AGND.
3	SW	**Switching Node.** This pin is connected to the internal MOSFET switches.
4	PV_{IN}	**Supply Voltage Input.** This pin is connected to the internal MOSFET switches.
5	V_{IN}	**Supply Voltage Input.**
6	EN	**Enable Input.** Logic high enables the chip and logic low disables the chip, reducing the supply current to less than 1µA. Do not float this pin.

Absolute Maximum Ratings (Note1)

Parameter		Min	Max	Unit
V_{IN}, PV_{IN}		-0.3	7	V
Voltage On Any Other Pin		-0.3	V_{IN}	V
Lead Soldering Temperature (10 seconds)			260	°C
Junction Temperature			150	°C
Storage Temperature		-65	150	°C
Thermal Resistance-Junction to Tab (θ_{JC}), 3x3mm 6-lead MLP (Note 2)			8	°C/W
Electrostatic Discharge Protection (ESD) Level (Note 3)	HBM	4		kV
	CDM	1		

Recommended Operating Conditions

Parameter	Min	Typ	Max	Unit
Supply Voltage Range	2.5		5.5	V
Output Voltage Range, Adjustable Version	0.8		V_{IN}	V
Output Current			1	A
Inductor (Note 4)		3.3		µH
Input Capacitor (Note 4)		10		µF
Output Capacitor (Note 4)		2 x 10		µF
Operating Ambient Temperature Range	-40		+85	°C
Operating Junction Temperature Range	-40		+125	°C

Notes:

1. Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Absolute maximum ratings apply individually only, not in combination. Unless otherwise specified, all other voltages are referenced to AGND.
2. Junction to ambient thermal resistance, θ_{JA}, is a strong function of PCB material, board thickness, thickness and number of copper planes, number of via used, diameter of via used, available copper surface, and attached heat sink characteristics.
3. Using Mil Std. 883E, method 3015.7(Human Body Model) and EIA/JESD22C101-A (Charge Device Model).
4. Refer to the applications section for further details.

Electrical Characteristics

$V_{IN} = V_{OUT} + 0.6V$(min. 2.5V) to 5.5V, I_{OUT} = 350mA, V_{OUT} =1.2V, EN = V_{IN}, T_A = -40°C to +85°C, Unless otherwise noted. Typical values are at T_A = 25°C.

Symbol	Parameter	Conditions		Min.	Typ.	Max.	Units
V_{IN}	Input Voltage	0 mA ≤ I_{OUT} ≤ 600 mA		2.5		5.5	V
		0 mA ≤ I_{OUT} ≤ 1000 mA		2.7		5.5	V
I_Q	Quiescent Current	I_{OUT} = 0mA, Device is not switching			20	35	µA
		I_{OUT} = 0mA, Device is switching (Note 5)	R2 =10KΩ		50		µA
			R2 =100KΩ		25		µA
	Shutdown Supply Current	EN = GND			0.1	1	µA
	Undervoltage Lockout Threshold	V_{IN} Rising		1.9	2.1	2.3	V
		Hysteresis			150		mV
V_{ENH}	Enable High Input Voltage			1.3			V
V_{ENL}	Enable Low Input Voltage					0.4	V
I_{EN}	EN input bias current	EN = V_{IN} or GND			0.01	0.1	µA
R_{DS-ON}	PMOS On Resistance	V_{IN} = V_{GS} = 5.5V			250	350	mΩ
		V_{IN} = V_{GS} = 2.5V			300	400	
	NMOS On Resistance	V_{IN} = V_{GS} = 5.5V			200	300	mΩ
		V_{IN} = V_{GS} = 2.5V			250	350	
I_{LIM}	P-channel current limit	2.5V < V_{IN} < 5.5V		1300	1500	2000	mA
	Oscillator frequency			1000	1300	1500	KHz
$I_{lkg_(N)}$	N-channel leakage current	V_{DS} = 5.5V			0.1	1	µA
$I_{lkg_(P)}$	P-channel leakage current	V_{DS} = 5.5V			0.1	1	µA
	Line regulation	I_{OUT} ≤ 10 mA			0.16		%/V
	Load regulation	350 mA ≤ I_{OUT} ≤ 1000 mA			0.15		%
Vref	Reference Voltage				0.8		V
	Output DC Voltage Accuracy (Note 6)	0 mA ≤ I_{OUT} ≤ 1000 mA		-3		+3	%
	Over-Temperature Protection	PWM Mode Only 350 mA ≤ I_{OUT} ≤ 1000 mA	Rising Temperature		150		°C
			Hysteresis		20		°C
	Start-Up Time	I_{OUT} = 1000 mA, C_{OUT} = 20 µF			800		µS

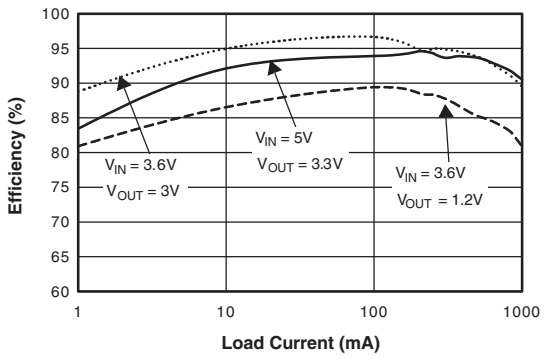
Notes:

5. Refer to the application section for further details.
6. For output voltages ≤ 1.2V a 40µF output capacitor value is required to achieve a maximum output accuracy of 3% while operating in power save mode (PFM mode).

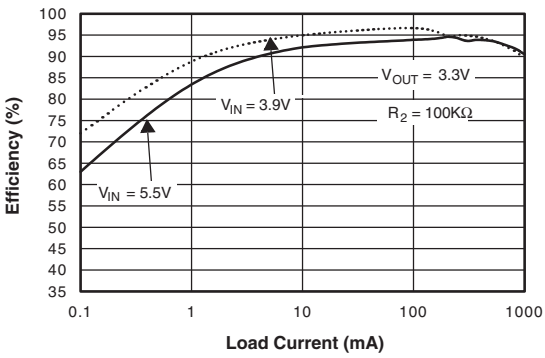
Typical Performance Characteristics

T_A = 25°C, C_{IN} = 10µF, C_{OUT} = 20µF, L = 3.3µH, R_2 = 10KΩ, unless otherwise noted.

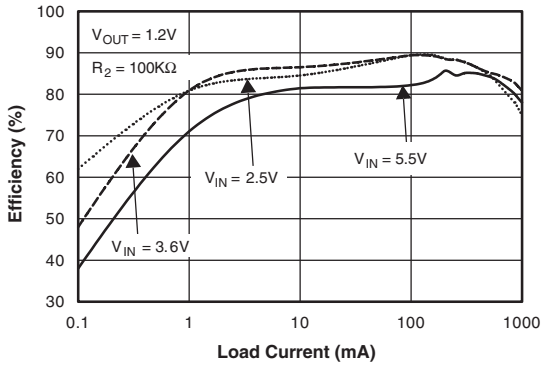
Efficiency vs. Load Current



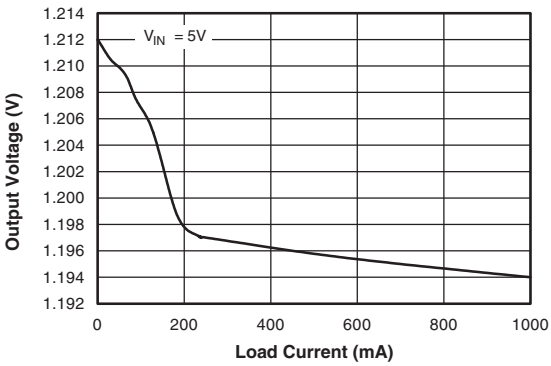
Efficiency vs. Load Current



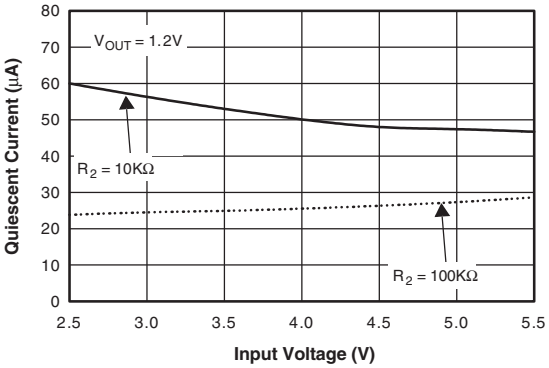
Efficiency vs. Load Current



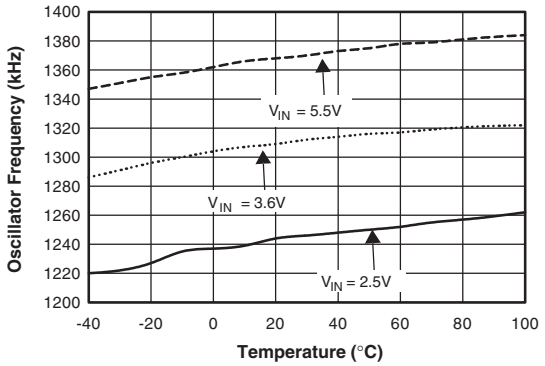
Output Voltage vs. Load Current



Quiescent Current vs. Input Voltage



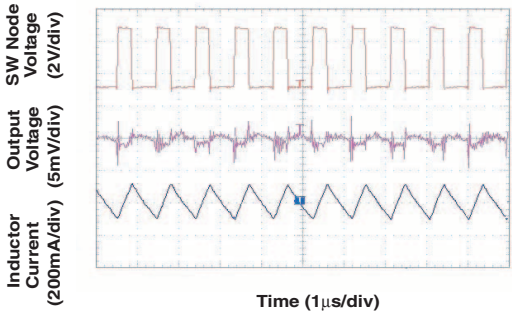
Frequency vs. Temperature



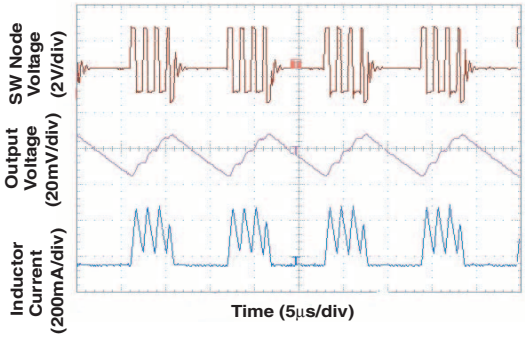
Typical Performance Characteristics (Contd.)

T_A = 25°C, C_{IN} = 10µF, C_{OUT} = 20µF, L = 3.3µH, R_2 = 10KΩ, unless otherwise noted.

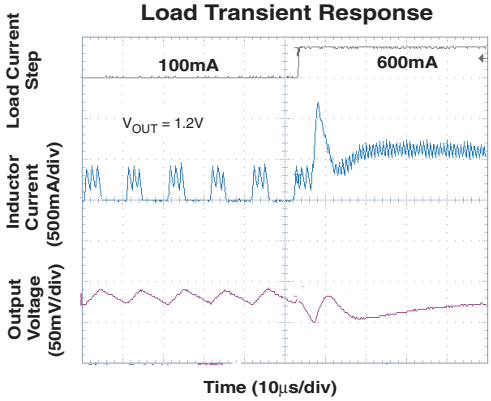
PWM Mode



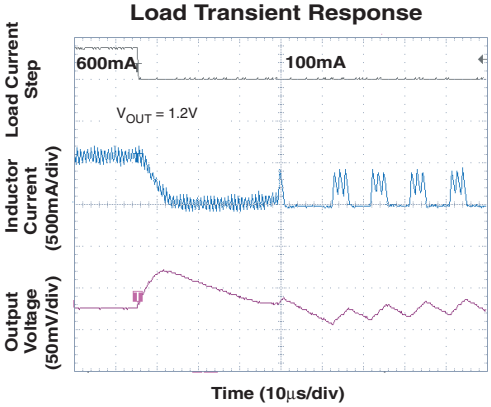
Power Save Mode



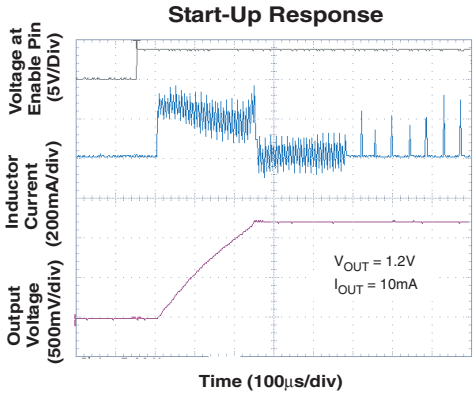
Load Transient Response



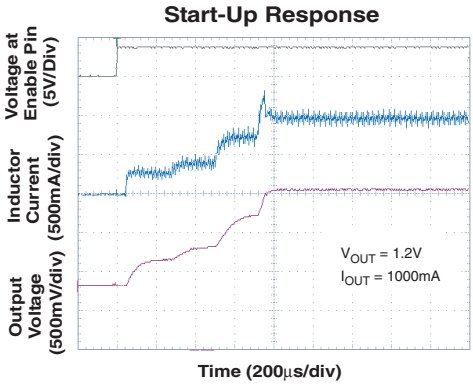
Load Transient Response



Start-Up Response



Start-Up Response



Block Diagram

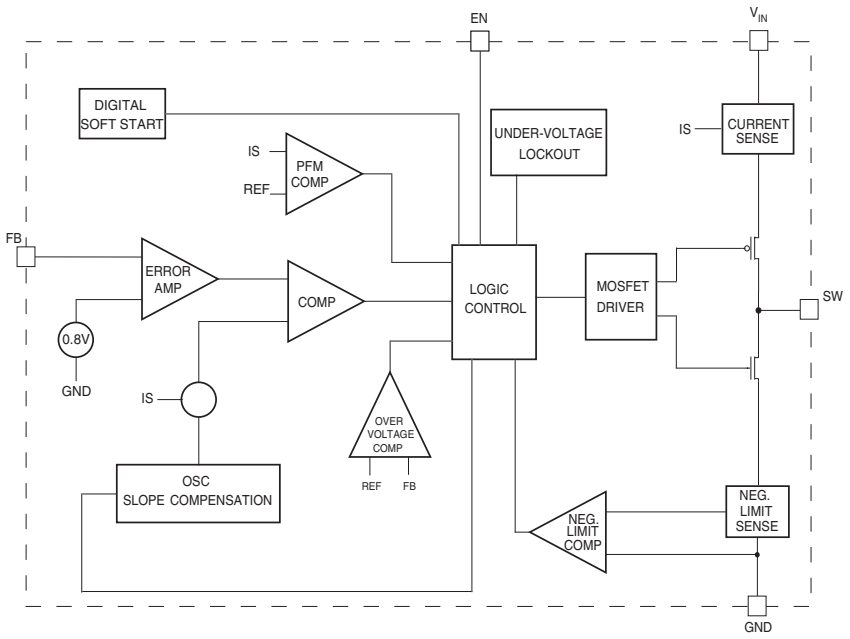


Figure 3. Block Diagram

Detailed Operation Description

The FAN2001/FAN2002 is a step-down converter operating in a current-mode PFM/PWM architecture with a typical switching frequency of 1.3MHz. At moderate to heavy loads, the converter operates in pulse-width-modulation (PWM) mode. At light loads the converter enters a power-save mode (PFM pulse skipping) to keep the efficiency high.

PWM Mode

In PWM mode, the device operates at a fixed frequency of 1.3MHz. At the beginning of each clock cycle, the P-channel transistor is turned on. The inductor current ramps up and is monitored via an internal circuit. The P-channel switch is turned off when the sensed current causes the PWM comparator to trip when the output voltage is in regulation or when the inductor current reaches the current limit (set internally to typically 1500mA). After a minimum dead time the N-channel transistor is turned on and the inductor current ramps down. As the clock cycle is completed, the N-channel switch is turned off and the next clock cycle starts.

PFM (Power Save) Mode

As the load current decreases and the inductor current reaches negative value, the converter enters pulse-frequency-modulation (PFM) mode. The transition point for the PFM mode is given by the equation:

$$I_{OUT} = V_{OUT} \times \frac{1 - (V_{OUT}/V_{IN})}{2 \times L \times f}$$

The typical output current when the device enters PFM mode is 150mA for input voltage of 3.6V and output voltage of 1.2V. In PFM mode the device operates with a variable frequency and constant peak current, thus reducing the quiescent current to minimum. Consequently, the high efficiency is maintained at light loads. As soon as the output voltage falls below a threshold, set at 0.8% above the nominal value, the P-channel transistor is turned on and the inductor current ramps up. The P-channel switch turns off and the N-channel turns on as the peak inductor current is reached (typical 450mA).

The N-channel transistor is turned off before the inductor current becomes negative. At this time the P-channel is switched on again starting the next pulse. The converter continues these pulses until the high threshold (typical 1.6% above nominal value) is reached. A higher output voltage in PFM mode gives additional headroom for the voltage drop during a load transient from light to full load. The voltage overshoot during this load transient is also minimized due to active regulation during turn on of the N-channel rectifier switch. The device stays in sleep mode until the output voltage falls below the low threshold. The FAN2001/FAN2002 enters the PWM mode as soon as the output voltage can no longer be regulated in PFM with constant peak current.

100% Duty Cycle Operation

As the input voltage approaches the output voltage and the duty cycle exceeds the typical 95%, the converter turns the P-channel transistor continuously on. In this mode the output voltage is equal to the input voltage minus the voltage drop across the P-channel transistor:

$V_{OUT} = V_{IN} - I_{LOAD} \times (R_{dsON} + R_L)$, where

R_{dsON} = P-channel switch ON resistance
I_{LOAD} = Output current
R_L = Inductor DC resistance

UVLO and Soft Start

The reference and the circuit remain reset until the V_{IN} crosses its UVLO threshold.

The FAN2001/FAN2002 has an internal soft-start circuit that limits the in-rush current during start-up. This prevents possible voltage drops of the input voltage and eliminates the output voltage overshoot. The soft-start is implemented as a digital circuit increasing the switch current in four steps to the P-channel current limit (1500mA). Typical start-up time for a 20µF output capacitor and a load current of 1000mA is 800µs.

Short Circuit Protection

The switch peak current is limited cycle-by-cycle to a typical value of 1500mA. In the event of an output voltage short circuit, the device operates with a frequency of 400kHz and minimum duty cycle, therefore the average input current is typically 200mA.

Thermal Shutdown

When the die temperature exceeds 150°C, a reset occurs and will remain in effect until the die cools to 130°C, at that time the circuit will be allowed to restart.

Applications Information

Setting the Output Voltage

The internal reference is 0.8V (Typical). The output voltage is divided by a resistor divider, R1 and R2 to the FB pin. The output voltage is given by:

$$V_{OUT} = V_{REF}\left(1 + \frac{R_1}{R_2}\right)$$

Where $R_1 + R_2 < 800K\Omega$.

According to this equation, and assuming desired output voltage of 1.5096V, and given R2 = 10KΩ, the calculated value of R1 is 8.87KΩ. If quiescent current is a key design parameter a higher value feedback resistor can be used (e.g. R2 = 100KΩ) and a small bypass capacitor of 10pF is required in parallel with the upper resistor as shown in Figure 4.

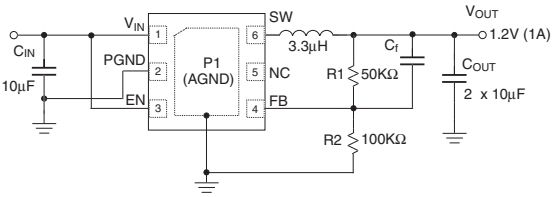


Figure 4. Setting the Output Voltage

Inductor Selection

The inductor parameters directly related to the device's performances are saturation current and dc resistance. The FAN2001/FAN2002 operates with a typical inductor value of 3.3µH. The lower the dc resistance, the higher the efficiency. For saturation current, the inductor should be rated higher than the maximum load current plus half of the inductor ripple current.

This is calculated as follows:

$$\Delta I_L = V_{OUT} \times \frac{1 - (V_{OUT}/V_{IN})}{L \times f}$$

where:
ΔI_L = Inductor Ripple Current
f = Switching Frequency
L = Inductor Value

Some recommended inductors are suggested in the table below:

Inductor Value	Vendor	Part Number
3.3µH	Panasonic	ELL6PM3R3N
3.3µH	Murata	LQS66C3R3M04

Table 1: Recommended Inductors

Capacitors Selection

For best performances, a low ESR input capacitor is required. A ceramic capacitor of at least 10µF, placed as close to the V_{IN} and AGND pins of the device is recommended. The output capacitor determines the output ripple and the transient response.

Capacitor Value	Vendor	Part Number
10µF	Taiyo Yuden	JMK212BJ106MG
		JMK316BJ106KL
	TDK	C2012X5ROJ106K
		C3216X5ROJ106M
	Murata	GRM32ER61C106K

Table 2: Recommended Capacitors

PCB Layout Recommendations

The recommended PCB layout is shown in Figures 5 and 6. The inherently high peak currents and switching frequency of power supplies require a careful PCB layout design.

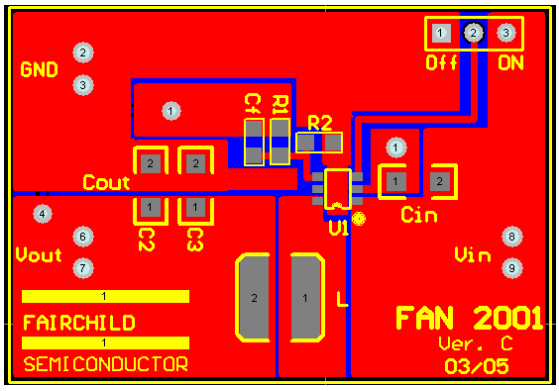


Figure 5. Recommended PCB Layout (FAN2001)

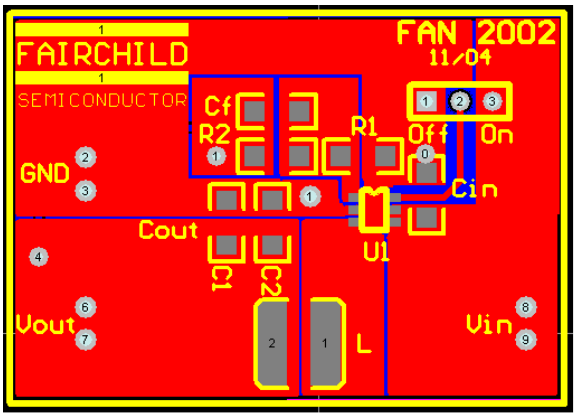


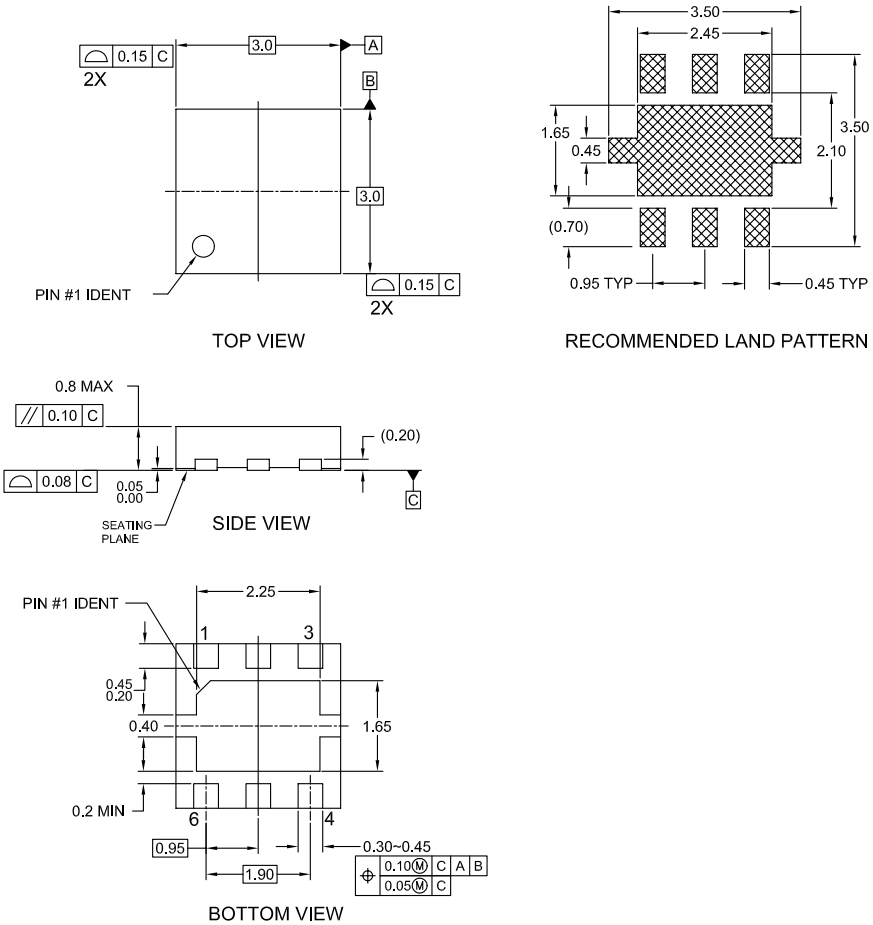
Figure 6. Recommended PCB Layout (FAN2002)

Therefore, use wide traces for high current paths and place the input capacitor, the inductor, and the output capacitor as close as possible to the integrated circuit terminals. In order to minimize voltage stress to the device resulting from ever present switching spikes, use an input bypass capacitor with low ESR. Note that the peak amplitude of the switching spikes depends upon the load current; the higher the load current, the higher the switching spikes. The resistor divider that sets the output voltage should be routed away from the inductor to avoid RF coupling. The ground plane at the bottom side of the PCB acts as an electromagnetic shield to reduce EMI.

For more board layout recommendations download the application note “PCB Grounding System and FAN2001/FAN2011 High Performance DC-DC Converters” (AN-42036).

Mechanical Dimensions

3x3mm 6-Lead MLP



NOTES:

A. CONFORMS TO JEDEC REGISTRATION MO-229, VARIATION WEEA, DATED 11/2001 EXCEPT FOR DAP EXTENSION TABS

B. DIMENSIONS ARE IN MILLIMETERS.

C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994

Ordering Information

Product Number	Output Voltage	Package Type	Order Code
FAN2001	Adjustable	3x3mm 6-Lead MLP	FAN2001MPX
FAN2002	Adjustable	3x3mm 6-Lead MLP	FAN2002MPX

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CoolFET™	FRFET™	MICROCOUPLER™	PowerSaver™	SuperSOT™-3
CROSSVOLT™	GlobalOptoisolator™	MicroFET™	PowerTrench®	SuperSOT™-6
DOME™	GTO™	MicroPak™	QFET®	SuperSOT™-8
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